



# MMDTA42

## **DUAL NPN SMALL SIGNAL SURFACE MOUNT TRANSISTOR**

## **Features**

Epitaxial Planar Die Construction

Ideal for Medium Power Amplification and Switching

Lead Free/RoHS Compliant (Note 3)

"Green" Device, Note 4 and 5

## **Mechanical Data**

Case: SOT-26

Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification

Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020C

Terminal Connections: See Diagram

Terminals: Finish - Matte Tin Solderable per

MIL-STD-202, Method 208

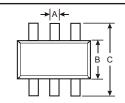
Lead Free Plating (Matte Tin Finish annealed over

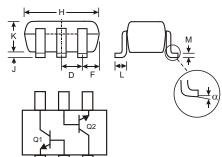
Copper leadframe).

Marking (See Page 2): K3M

Ordering & Date Code Information: See Page 2

Weight: 0.008 grams (approximate)





SOT-26									
Dim	Min	Max	Тур						
Α	0.35	0.50	0.38						
В	1.50	1.70	1.60						
С	2.70	3.00	2.80						
D			0.95						
F			0.55						
Н	2.90	3.10	3.00						
J	0.013	0.10	0.05						
K	1.00	1.30	1.10						
L	0.35	0.55	0.40						
M	0.10	0.20	0.15						
	0	8							
All Dimensions in mm									

#### **Maximum Ratings** @ T<sub>A</sub> = 25 C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Collector-Base Voltage	V <sub>CBO</sub>	300	V	
Collector-Emitter Voltage	V <sub>CEO</sub>	300	V	
Emitter-Base Voltage	V <sub>EBO</sub>	6.0	V	
Collector Current (Note 1) (Note 2)	I <sub>C</sub>	500	mA	
Power Dissipation (Note 1)	P <sub>d</sub>	300	mW	
Thermal Resistance, Junction to Ambient (Note 1)	R JA	417	C/W	
Operating and Storage and Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-55 to +150	С	

- Notes: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
  - 2. When operated under collector-emitter saturation conditions within the safe operating area defined by the thermal resistance rating (R JA), power dissipation rating (P<sub>d</sub>) and power derating curve (figure 1).
  - 3. No purposefully added lead.
  - 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com./products/lead\_free/index.php.
  - 5. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



# Electrical Characteristics @ TA = 25 C unless otherwise specified

查询"MMDTA42"共存。商ic	Symbol	Min	Max	Unit	Test Condition				
OFF CHARACTERISTICS (Note 6)									
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	300		V	I <sub>C</sub> = 100 A, I <sub>E</sub> = 0				
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	300		V	$I_C = 1.0 \text{mA}, I_B = 0$				
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	6.0		V	I <sub>E</sub> = 100 A, I <sub>C</sub> = 0				
Collector Cutoff Current	I <sub>CBO</sub> 100 nA V <sub>CB</sub> = 200V,		V <sub>CB</sub> = 200V, I <sub>E</sub> = 0						
Collector Cutoff Current			100	nA	$V_{CE} = 6.0V, I_{C} = 0$				
ON CHARACTERISTICS (Note 6)									
DC Current Gain	h <sub>FE</sub>	25 40 40			I <sub>C</sub> = 1.0mA, V <sub>CE</sub> = 10V I <sub>C</sub> = 10mA, V <sub>CE</sub> = 10V I <sub>C</sub> = 30mA, V <sub>CE</sub> = 10V				
Collector-Emitter Saturation Voltage	V <sub>CE(SAT)</sub>		0.5	V	I <sub>C</sub> = 20mA, I <sub>B</sub> = 2.0mA				
Base-Emitter Saturation Voltage	V <sub>BE(SAT)</sub>		0.9	V	$I_C = 20mA, I_B = 2.0mA$				
SMALL SIGNAL CHARACTERISTICS									
Output Capacitance	C <sub>cb</sub>		3.0	pF	$V_{CB} = 20V, f = 1.0MHz, I_{E} = 0$				
Current Gain-Bandwidth Product	f⊤	50		MHz	V <sub>CE</sub> = 20V, I <sub>C</sub> = 10mA, f = 100MHz				

Notes: 6. Short duration test pulse used to minimize self-heating effect.

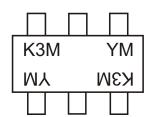
# Ordering Information (Note 5 & 7)

Device	Packaging	Shipping
MMDTA42-7-F	SOT-26	3000/Tape & Reel

Notes: 5. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

 $7. \ \ \text{For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.}$ 

# **Marking Information**



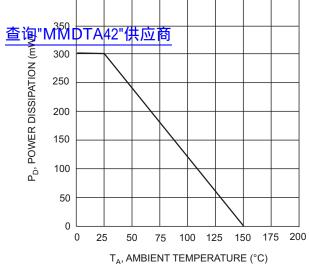
K3M = Product Type Marking Code YM = Date Code Marking Y = Year ex: P = 2003 M = Month ex: 9 = September

## Date Code Key

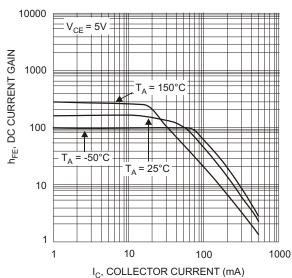
Year	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	R	S	Т	U	V	W	Х	Υ	Z

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

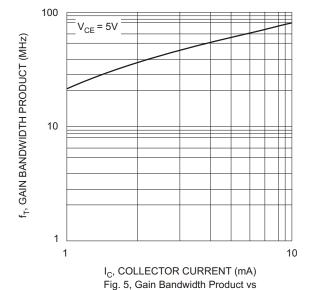




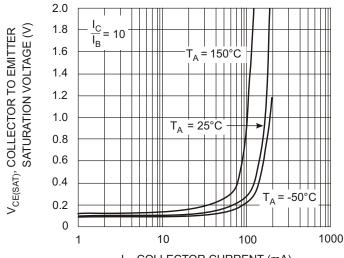
T<sub>A</sub>, AMBIENT TEMPERATURE (°C Fig. 1, Max Power Dissipation vs Ambient Temperature



, COLLECTOR CURRENT (mA Fig. 3, DC Current Gain vs Collector Current



Collector Current



I<sub>C</sub>, COLLECTOR CURRENT (mA)
Fig. 2, Collector Emitter Saturation Voltage
vs. Collector Current

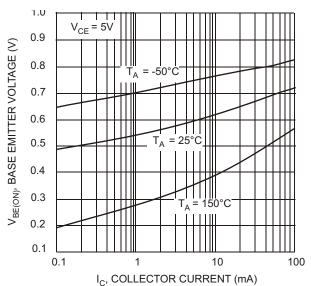


Fig. 4, Base Emitter Voltage vs Collector Current



## IMPORTANT NOTICE

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